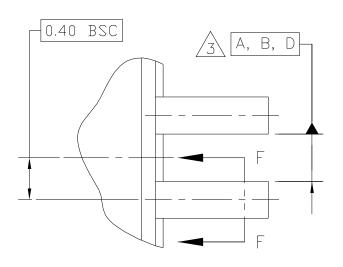
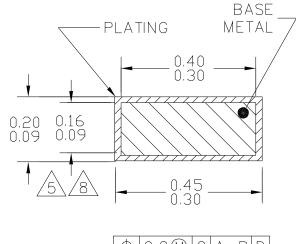


	MECHANICAL OU	TLINE	PRINT VERSION NOT	TO SCALE
TITLE:		DOCUMENT NO: 98ASH70029A		REV: F
LOW PROFILE QUAD FLAT PACK (LQFP)		STANDARD: JEDEC MS-026 BBA		
32 LEAD, 0.8 PITCH (7 X	/ X 1.4)	SDT358-	-3 C	1 APR 2016



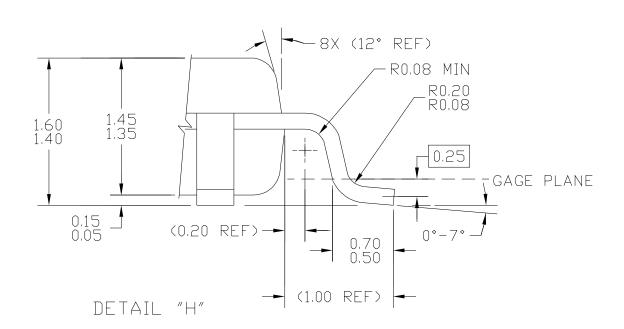


DETAIL G



⊕ 0.2 M C A−B D

SECTION F-F
ROTATED 90°CW
32 PLACES



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LOW PROFILE QUAD FLAT PACK (LQFP)		DOCUMEN	NT NO: 98ASH70029A	REV: F
		STANDARD: JEDEC MS-026 BBA		
32 LEAD, 0.8 PITCH (7)	X / X 1.4)	SDT358-	-3 0	1 APR 2016



NOTES:

- 1. DIMENSIONS ARE IN MILLIMETERS.
- 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5-1994.
- $\sqrt{3}$ Datums A, B, and D to be determined at datum plane H.
- 4 dimensions to be determined at seating plane datum c.
- DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE MAXIMUM DIMENSION BY MORE THAN 0.08 MM. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD OR PROTRUSION: 0.07 MM.
- 6. DIMENSIONS DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 MM PER SIDE. DIMENSIONS ARE MAXIMUM PLASTIC BODY SIZE DIMENSIONS INCLUDING MOLD MISMATCH.
- A EXACT SHAPE OF EACH CORNER IS OPTIONAL.
- A. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.1 MM AND 0.25 MM FROM THE LEAD TIP.

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		DOCUMEN	NT NO: 98ASH70029A	REV: F
		STANDARD: JEDEC MS-026 BBA		
32 LEAD, 0.8 PITCH (7 X	/ X 1.4)	SDT358-	-3 01	APR 2016